

This diagram shows a cross-section of a device assembly. On the left, a hatched area labeled '3' represents a substrate or support. To its right are two horizontal layers labeled '6a' and '6b'. Between these layers is a central vertical stack of components. From top to bottom, this stack consists of: a thin layer '8'; a textured layer '5a'; a rectangular component '2' with internal horizontal lines; a circular component '1' with concentric circles; another rectangular component '2'; a textured layer '5c'; and a thin layer '8'. Flanking this central stack are four vertical rectangular components: '4a' at the top, '4d' below it, '4c' below that, and '4b' at the bottom. To the right of these flanking components is another vertical stack consisting of a textured layer '5d' and a thin layer '8'.

FIG. 2

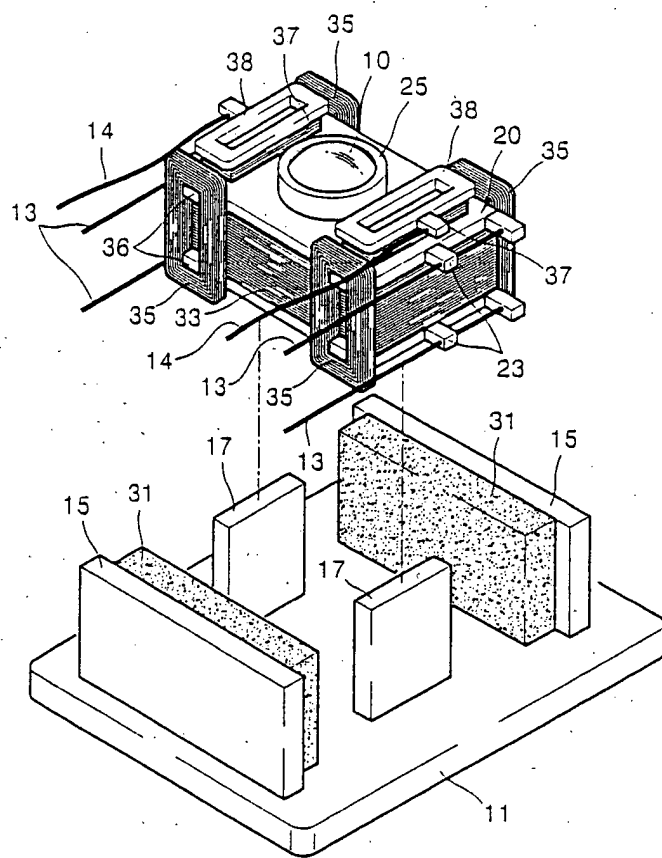


FIG. 3

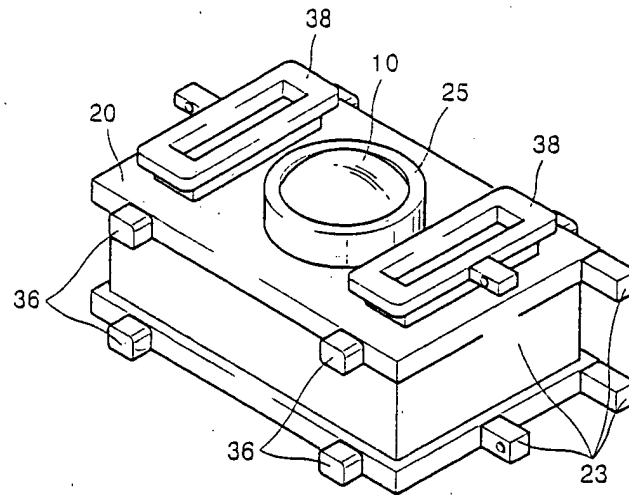


FIG. 4

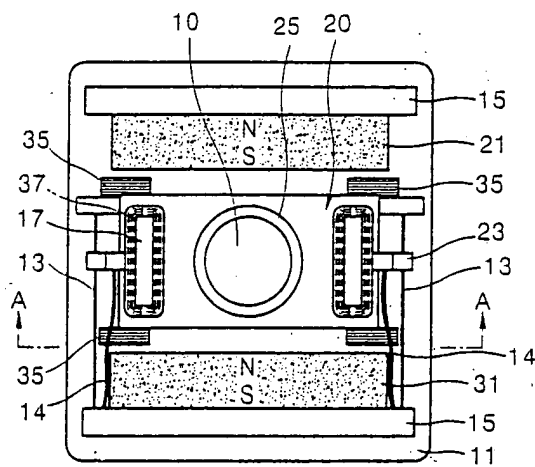


FIG. 5

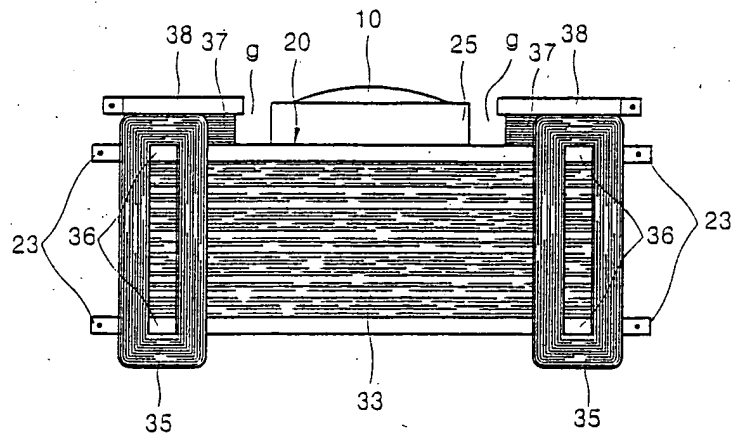


FIG. 6

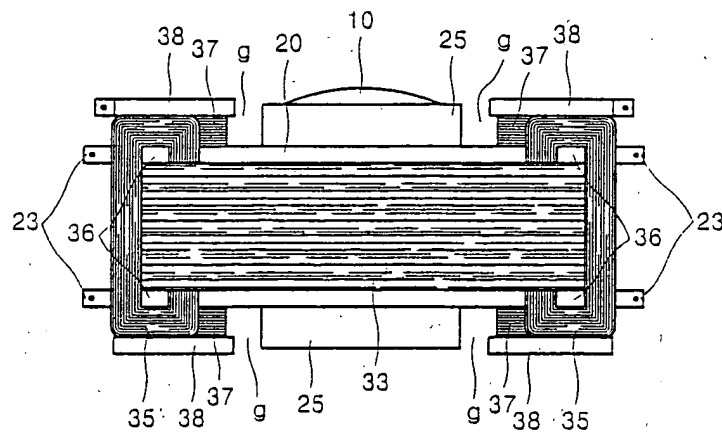


FIG. 7

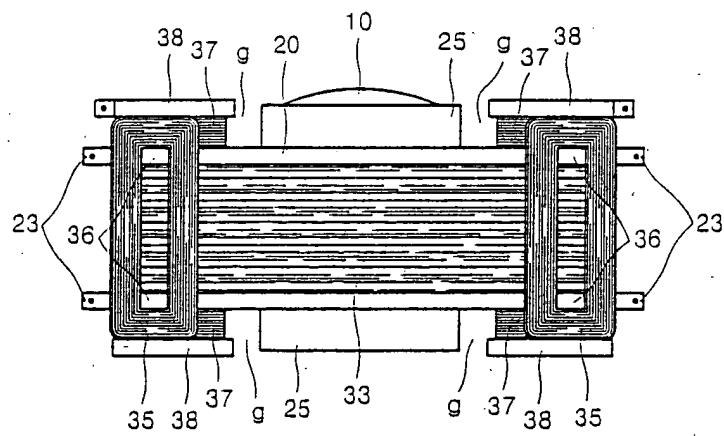


FIG. 8

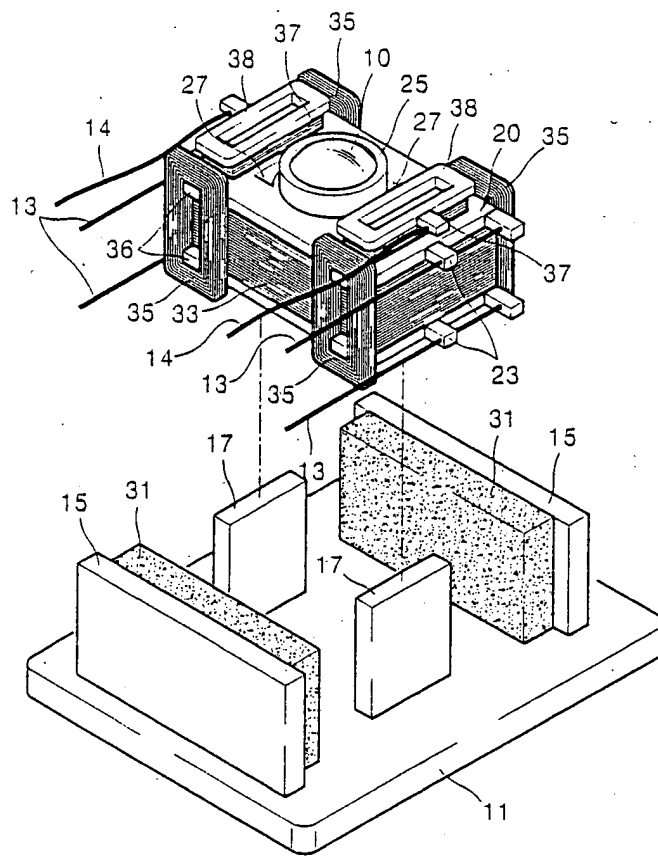


FIG. 9

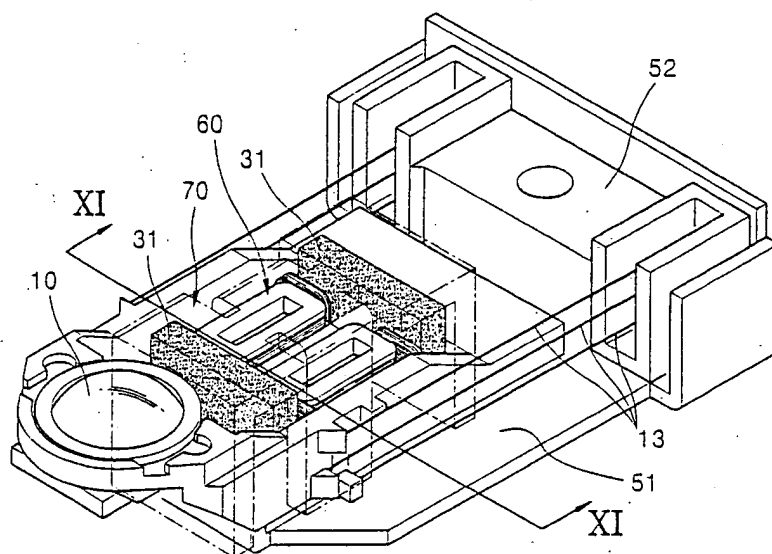


FIG. 10

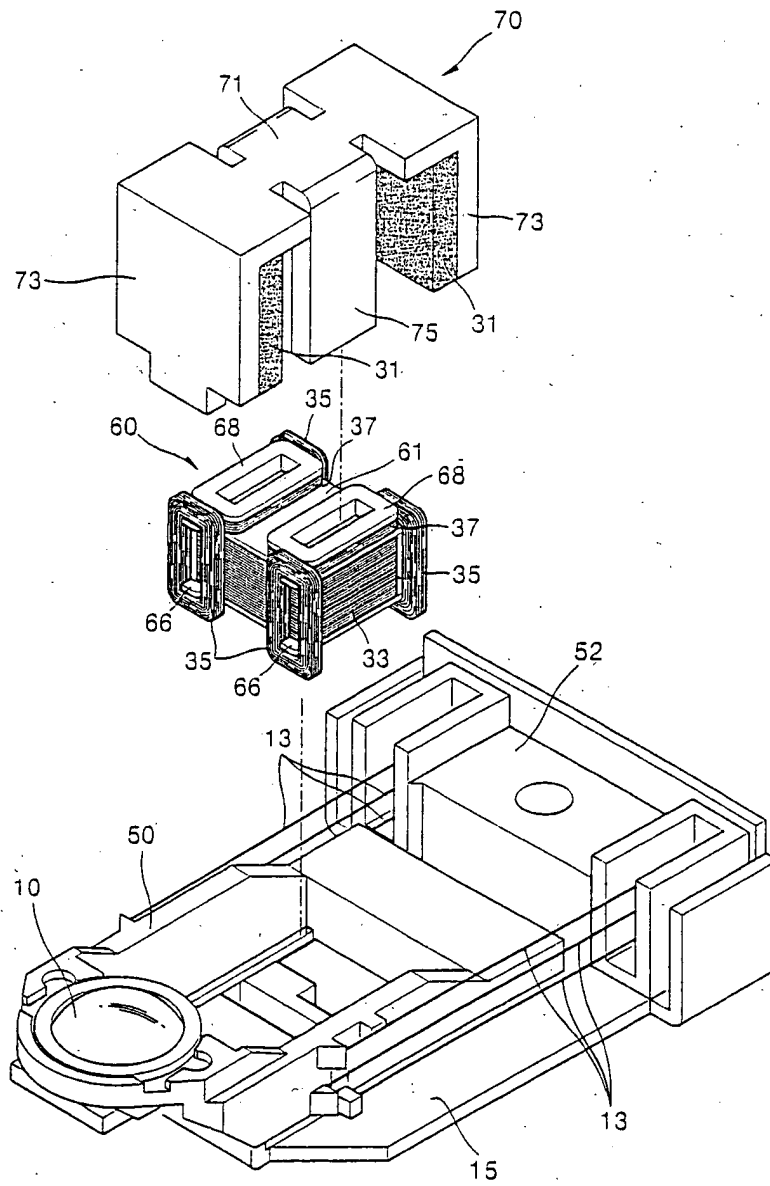




FIG. 11

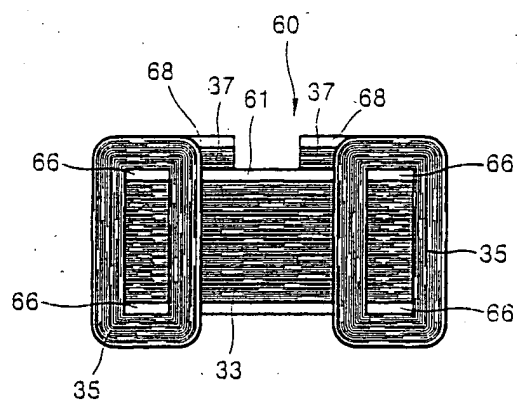


FIG. 12

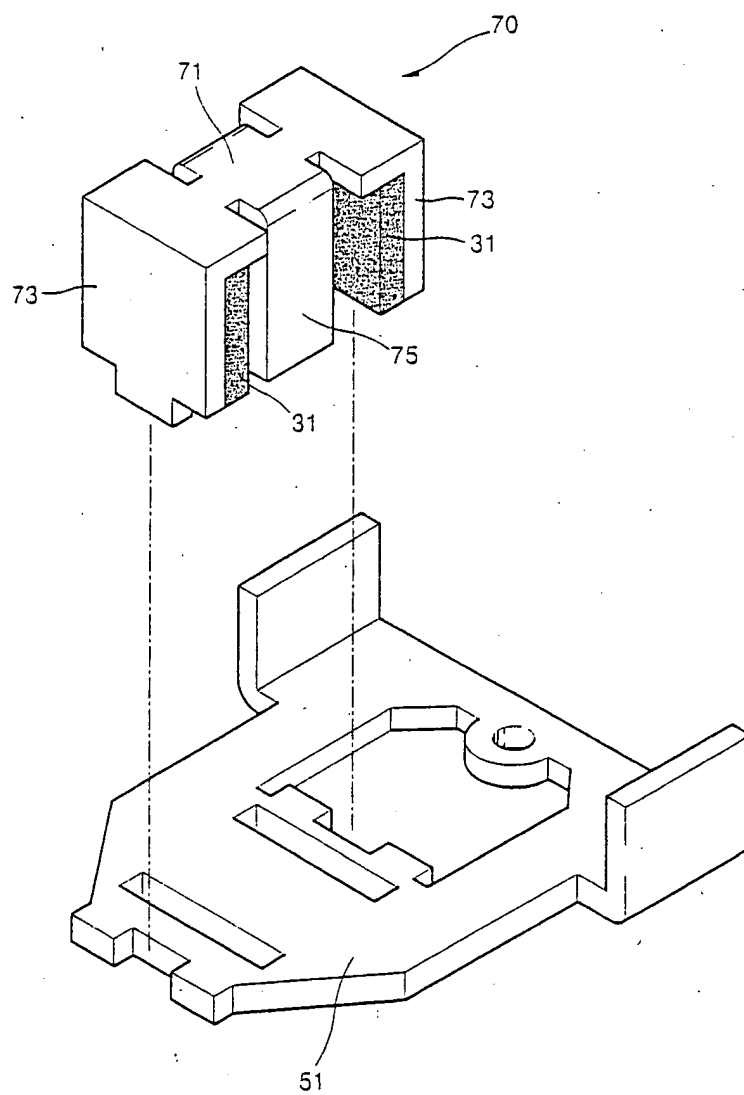


FIG. 13

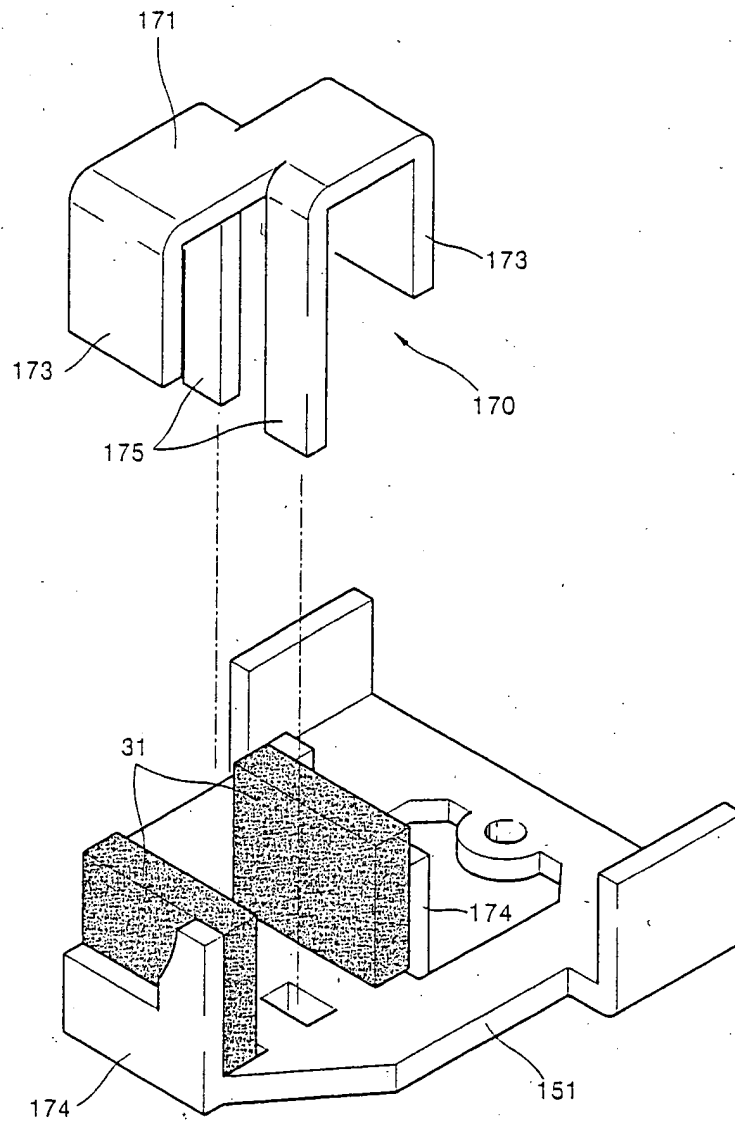


FIG. 14

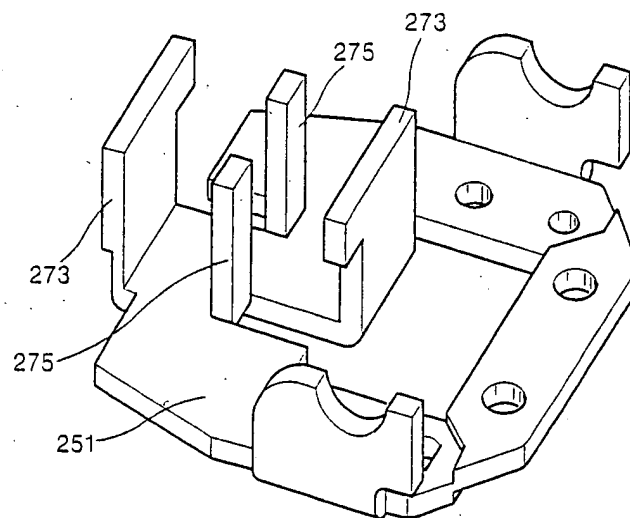


FIG. 15

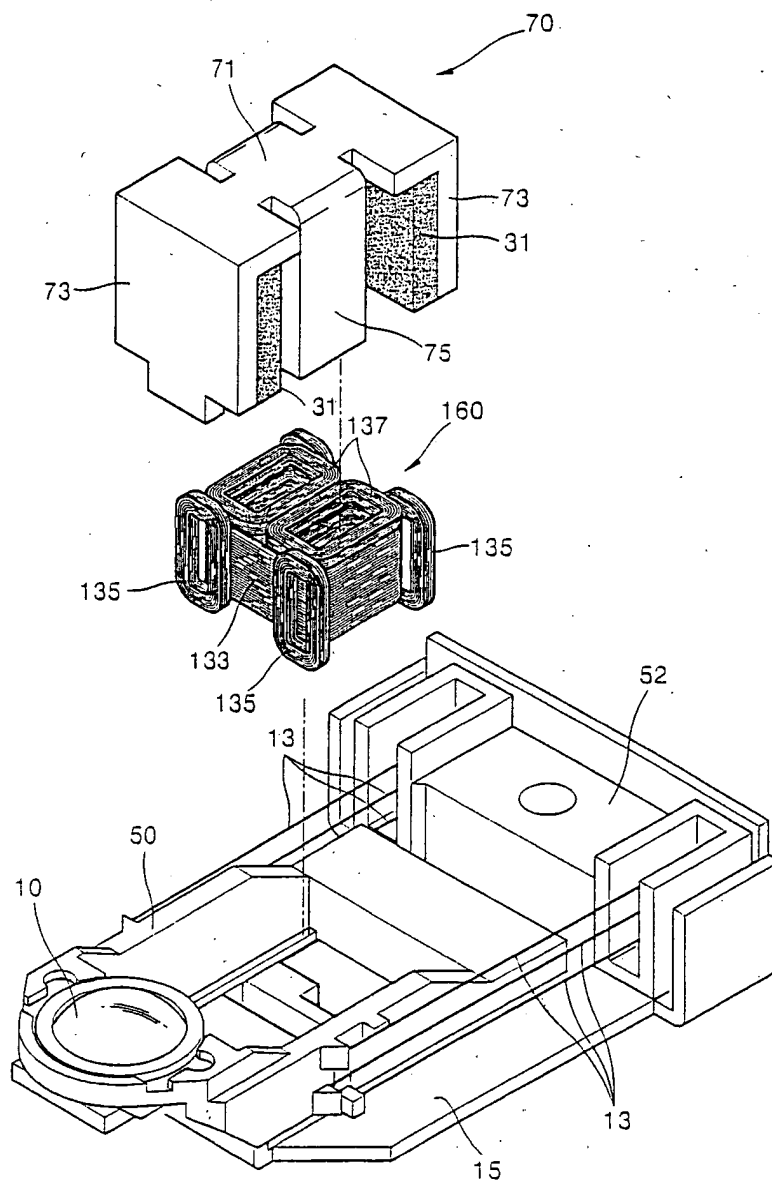


FIG. 16

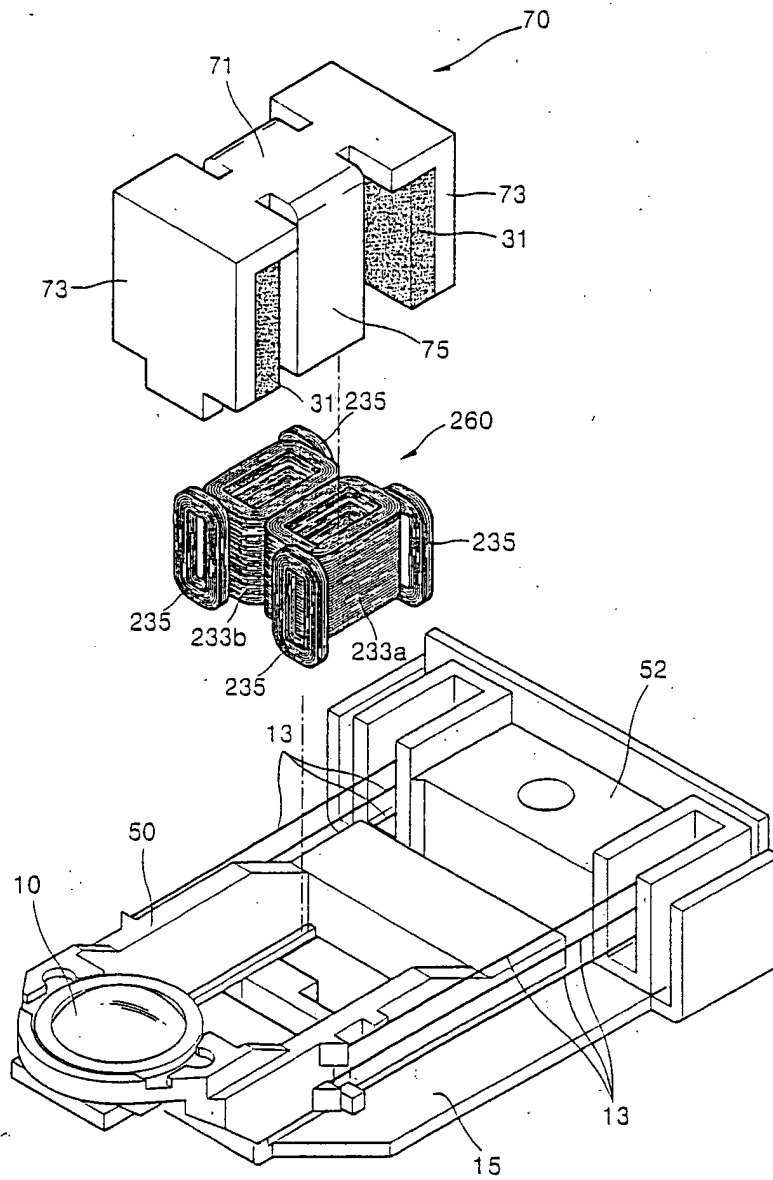


FIG. 17

